

Rev. 03 — 28 September 2007

**Product data sheet** 

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**NXP Semiconductors** 



NXP Semiconductors Product specification

## **NPN 4 GHz wideband transistor**

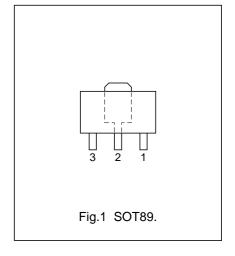
BFQ18A

### **DESCRIPTION**

NPN transistor in a plastic SOT89 envelope intended for application in thick and thin-film circuits. It is primarily intended for MATV purposes.

#### **PINNING**

PIN	PIN DESCRIPTION			
Code: FF				
1	emitter			
2	collector			
3	base			



#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	25	٧
V <sub>CEO</sub>	collector-emitter voltage	open base	_	18	V
Ic	DC collector current		_	150	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>s</sub> = 155 °C (note 1)	_	1	W
f <sub>T</sub>	transition frequency	$I_C = 100 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz};$ $T_j = 25 \text{ °C}$	4	_	GHz
C <sub>re</sub>	feedback capacitance	I <sub>C</sub> = 0; V <sub>CE</sub> = 10 V; f = 10.7 MHz	1.2	_	pF
d <sub>im</sub>	intermodulation distortion	$I_C$ = 80 mA; $V_{CE}$ = 10 V; $R_L$ = 75 Ω; $V_o$ = 700 mV; measured at $f_{(p+q-r)}$ = 793.25 MHz	_	-60	dB

### **LIMITING VALUES**

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	25	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	18	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	2	V
Ic	DC collector current		-	150	mA
P <sub>tot</sub>	total power dissipation	up to T <sub>s</sub> = 155 °C (note 1)	-	1	W
T <sub>stg</sub>	storage temperature		-65	150	°C
Tj	junction temperature		-	175	°C

### Note

1.  $T_s$  is the temperature at the soldering point of the collector tab.

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### THERMAL RESISTANCE

SYMBOL	PARAMETER	CONDITIONS	THERMAL RESISTANCE
R <sub>th j-s</sub>	thermal resistance from junction to soldering point	up to $T_s = 155$ °C (note 1)	20 K/W

#### Note

1.  $T_s$  is the temperature at the soldering point of the collector tab.

### **CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	UNIT
h <sub>FE</sub>	DC current gain	I <sub>C</sub> = 100 mA; V <sub>CE</sub> = 10 V	25	_	
C <sub>c</sub>	collector capacitance	$I_E = i_e = 0$ ; $V_{CB} = 10 \text{ V}$ ; $f = 1 \text{ MHz}$	_	2	pF
Ce	emitter capacitance	$I_C = I_c = 0$ ; $V_{EB} = 0.5 \text{ V}$ ; $f = 1 \text{ MHz}$	_	11	pF
C <sub>re</sub>	feedback capacitance	I <sub>C</sub> = 0; V <sub>CE</sub> = 10 V; f = 10.7 MHz	_	1.2	pF
f <sub>T</sub>	transition frequency	I <sub>C</sub> = 100 mA; V <sub>CE</sub> = 10 V; f = 500 MHz	_	4	GHz
d <sub>im</sub>	intermodulation distortion (see Fig.2)	note 1	_	-60	dB

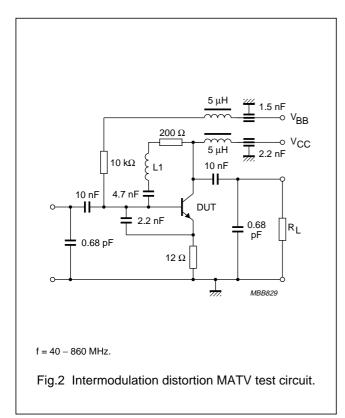
#### Note

1.  $I_c$  = 80 mA;  $V_{CE}$  = 10 V;  $R_L$  = 75  $\Omega$ ;  $V_p$  =  $V_o$  = 700 mV;  $f_p$  =795.25 MHz;  $V_q$  =  $V_o$  -6 dB;  $f_q$  = 803.25 MHz;  $V_r$  =  $V_o$  -6 dB;  $f_r$  = 805.25 MHz; measured at  $f_{(p+q-r)}$  = 793.25 MHz.

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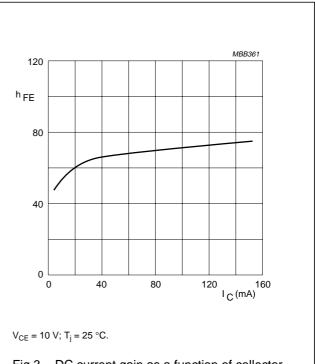
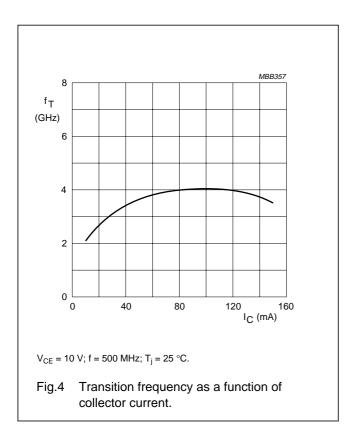


Fig.3 DC current gain as a function of collector current.



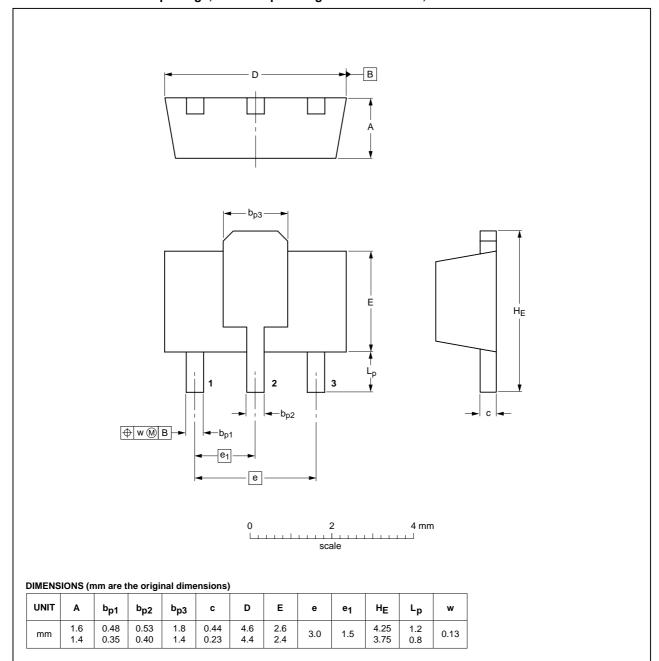
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### **PACKAGE OUTLINE**

## Plastic surface-mounted package; collector pad for good heat transfer; 3 leads

SOT89



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT89		TO-243	SC-62			<del>06-03-16</del> 06-08-29	

## Legal information

### **Data sheet status**

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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# **Revision history**

### **Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
BFQ18A_N_3	20070928	Product data sheet	-	BFQ18A_CNV_2
Modifications:	<ul><li>Fig. 1 and p</li></ul>	ackage outline updated		
BFQ18A_CNV_2	19950901	Product specification	-	-

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